



40V 175°C DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} max	I _D max T _C = +25°C
40V	$15m\Omega @ V_{GS} = 10V$	42A

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

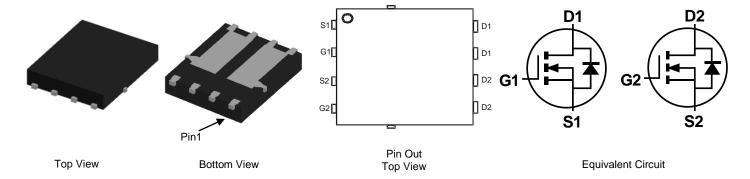
- Backlighting
- Power Management Functions
- DC-DC Converters

Features and Benefits

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On State Losses
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Datasheet (<u>DMTH4011SPDQ</u>)

Mechanical Data

- Case: PowerDI[®] 5060-8 (Type C)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 ⁽³⁾
- Weight: 0.097 grams (Approximate)



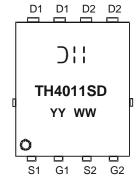
Ordering Information (Note 4)

Part Number	Case	Packaging
DMTH4011SPD-13	PowerDI5060-8 (Type C)	2,500/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



⊃!! = Manufacturer's Marking
 TH4011SD = Product Type Marking Code
 YYWW = Date Code Marking
 YY = Year (ex: 17 = 2017)
 WW = Week (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		V _{DSS}	40	V
Gate-Source Voltage		V_{GSS}	±20	V
Continuous Drain Current (Note 6)	$T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$	I _D	42 29.7	А
Continuous Drain Current (Note 5)	$T_A = +25^{\circ}C$ $T_A = +100^{\circ}C$	I _D	11.1 7.8	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I _{DM}	60	Α
Maximum Continuous Body Diode Forward Current (Note 6)		Is	3.3	Α
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)		I _{SM}	60	Α
Avalanche Current, L = 0.3mH		I _{AS}	11.9	Α
Avalanche Energy, L = 0.3mH		Eas	21.4	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	P_{D}	2.6	W	
Thermal Resistance, Junction to Ambient (Note 5)	R _{0JA}	57	°C/W	
Total Power Dissipation (Note 6)	P _D	37.5	W	
Thermal Resistance, Junction to Case (Note 6)		$R_{ heta JC}$	4	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +175	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	40	1		V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	I _{DSS}	ı	1	1	μA	$V_{DS} = 32V$, $V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	2	_	4	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	R _{DS(ON)}		11.6	15	mΩ	$V_{GS} = 10V, I_D = 20A$	
Diode Forward Voltage	V_{SD}	-	_	1.2	V	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C _{iss}	_	805	_	pF	.,	
Output Capacitance	Coss	_	208	_	pF	$V_{DS} = 20V$, $V_{GS} = 0V$, f = 1MHz	
Reverse Transfer Capacitance	Crss	_	15	_	pF		
Gate Resistance	R_g	_	2.76	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Q_g	_	10.6	_	nC	V _{DS} = 20V, I _D = 20A, V _{GS} = 10V	
Gate-Source Charge	Q_{gs}	_	2.2	_	nC		
Gate-Drain Charge	Q _{gd}	_	2.7	_	nC		
Turn-On Delay Time	t _{D(ON)}	_	4.1	_	ns	$V_{DD} = 20V, V_{GS} = 10V,$ $R_G = 1.6\Omega, I_D = 20A$	
Turn-On Rise Time	t _R	_	3.8	_	ns		
Turn-Off Delay Time	t _{D(OFF)}	_	8.6	_	ns		
Turn-Off Fall Time	t _F	_	1.9	_	ns		
Body Diode Reverse Recovery Time	t _{RR}	_	10.2	_	ns	I _F = 15A, di/dt = 400A/μs	
Body Diode Reverse Recovery Charge	Q _{RR}	_	9.6	_	nC		

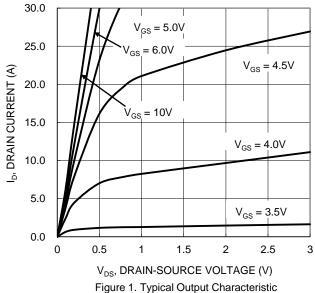
5. Device mounted on FR-4 substrate PC board, 2oz. copper, with thermal bias to bottom layer 1inch square copper plate.

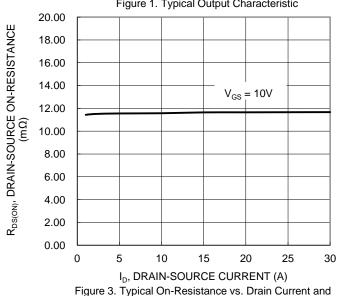
6. Thermal resistance from junction to soldering point (on the exposed drain pad).
7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.



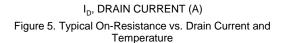






 $R_{DS(ON)}$, DRAIN-SOURCE ON-RESISTANCE (Ω) $V_{GS} = 10V$ 0.025 0.02 0.015 . 125°C $T_{J} = 85^{\circ}C$ 0.01 $T_1 = 25^{\circ}C$ $T_{.1} = -55^{\circ}C$ 0.005

Gate Voltage



15

20

25

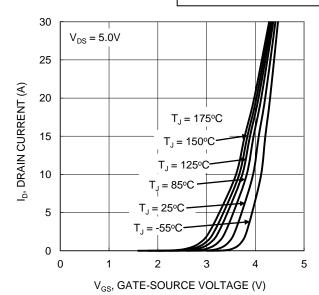


Figure 2. Typical Transfer Characteristic 100 $R_{\text{DS}(\text{ON})},$ DRAIN-SOURCE ON-RESISTANCE $(m\Omega)$ 90 80 $I_{D} = 20A$ 70 60 50 40 30 20 10 0

8

10 12 14

V_{GS}, GATE-SOURCE VOLTAGE (V)

16 18

2

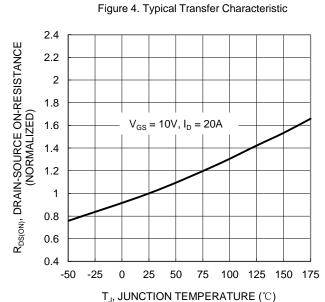


Figure 6. On-Resistance Variation with Temperature

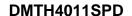
5

10

0 0

0.03

30





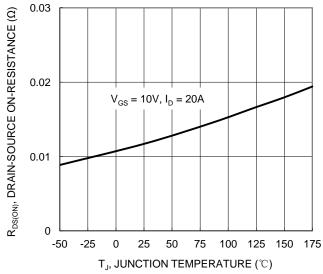


Figure 7. On-Resistance Variation with Temperature

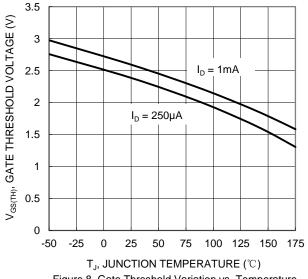
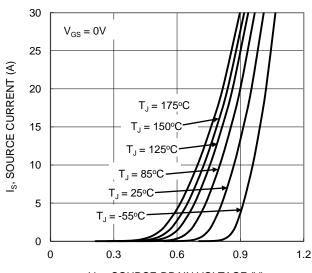


Figure 8. Gate Threshold Variation vs. Temperature



V_{SD}, SOURCE-DRAIN VOLTAGE (V) Figure 9. Diode Forward Voltage vs. Current

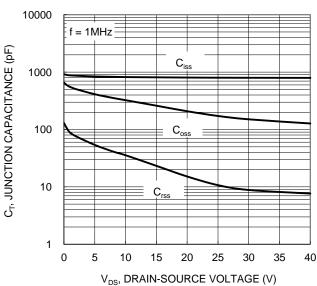


Figure 10. Typical Junction Capacitance

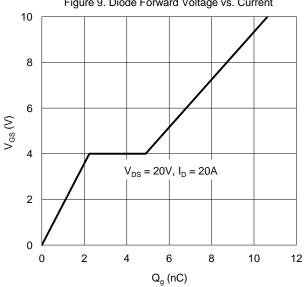


Figure 11. Gate Charge

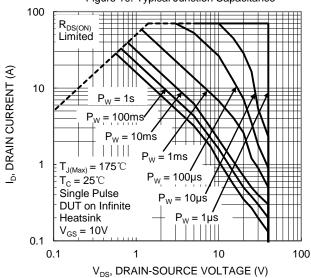


Figure 12. SOA, Safe Operation Area



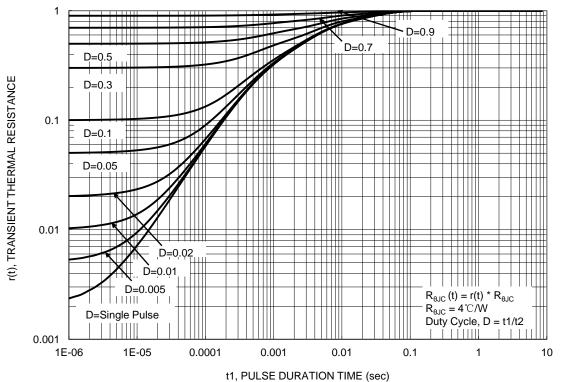


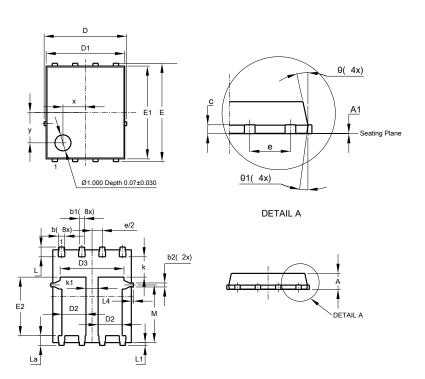
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (Type C)

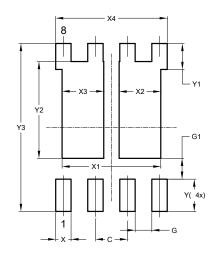


PowerDI5060-8 (Type C)					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0	0.05	0.02		
b	0.33	0.51	0.41		
b1	0.300	0.366	0.333		
b2	0.20	0.35	0.25		
С	0.23	0.33	0.277		
D		5.15 BSC)		
D1	4.85	4.95	4.90		
D2	1.40	1.60	1.50		
D3	-	-	3.98		
Е	(6.15 BSC)		
E1	5.75	5.85	5.80		
E2	3.56	3.76	3.66		
е		1.27BSC	,		
k	-	-	1.27		
k1	0.56	-	-		
L	0.51	0.71	0.61		
La	0.51	0.71	0.61		
L1	0.05	0.20	0.175		
L4	-	-	0.125		
М	3.50	3.71	3.605		
х	-	-	1.400		
у	-	-	1.900		
θ	10°	12°	11°		
θ1	6°	8°	7°		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (Type C)



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	3.910		
X2	1.650		
Х3	1.650		
X4	4.420		
Υ	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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